



April 22, 2010

### 56<sup>th</sup> Issuance of Domestic Unsecured Straight Bonds

ACOM CO., LTD. has reached a decision to make its 56<sup>th</sup> issuance of domestic unsecured straight bonds, as outlined below. The funds procured through this issuance will be used for partial repayment of long-term loans payable and redemption of bond maturing on May 10, 2010.

Registration relating to the issuance was carried out on July 2, 2009 and became effective as of July 10, 2009.

Name of issuance	ACOM CO., LTD. 56 <sup>th</sup> issuance of domestic unsecured straight bonds
Total value	20 billion yen
Interest rate	3.35% annually
Individual bond value	100 million yen
Issue price	Face value 100 yen
Redemption price	Face value 100 yen
Application period	April 22, 2010
Payment date	April 30, 2010
Maturation date	October 30, 2012
Application of funds procured	Partial repayment of long-term loans payable and redemption of bond maturing on May 10, 2010
Trustee	Daiwa Securities Capital Markets Co. Ltd. Deutsche Securities Inc.
Transfer agent	Mitsubishi UFJ Trust and Banking Corporation
Credit ratings	Japan Credit Rating Agency, Ltd.: A
	Rating and Investment Information, Inc.: A-

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#### **ACOM CO., LTD.**

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